



40V MATCHED PAIR NPN SMALL SIGNAL TRANSISTOR IN SOT363

#### **Features**

- BVceo > 40V
- I<sub>C</sub> = 200mA High Collector Current
- Pair of NPN Transistors that are Intrinsically Matched (Note 1)
- 2% Matching on Current Gain (h<sub>FE</sub>)
- 2mV Matching on Base-Emitter Voltage (V<sub>BE</sub>)
- Fully Internally Isolated in a Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 2 & 3)
- Halogen and Antimony Free. "Green" Device (Note 4)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 5)

#### **Mechanical Data**

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Finish. Solderable per MIL-STD-202, Method 208 3
- Weight: 0.006 grams (Approximate)

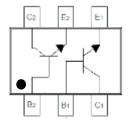
#### **Applications**

- Current Mirrors
- Differential and Instrumentation Amplifiers
- Comparators



SOT363

Top View



Device Schematic and Pin-Out Top View

#### Ordering Information (Notes 5 & 6)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DMMT3904W-7-F	AEC-Q101	K4A	7	8	3,000
DMMT3904WQ-7-F	Automotive	K4A	7	8	3,000

Notes:

1. Intrinsically matched pair as this is built with adjacent die from the same wafer.

2. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

3. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

4. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

5. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product\_compliance\_definitions/.

6. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

#### **Marking Information**

7	0010	0040	0000	0004	0000	0000	0004	000
		•	К4А	M M	YM = Y = Y	Date Cod ear (ex: F	Type Markin e Marking = 2018) 2 = Februar	0
			SOT363					

Date Code Key

Date Code Rey												
Year	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028
Code	E	F	G	Н	I	J	K	L	М	N	0	Р
Manth	lan	<b>F</b> ab	Max	A	Mari	l			a Com	Oct	Neur	Dee
Month	Jan	Feb	Mar	Apr	May	Jun	JL	II Au	g Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



#### Absolute Maximum Ratings (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	60	V
Collector-Emitter Voltage	V <sub>CEO</sub>	40	V
Emitter-Base Voltage	V <sub>EBO</sub>	6.0	V
Collector Current	Ιc	200	mA

## Thermal Characteristics – Total Device (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7) Total Device	PD	200	mW
Thermal Resistance, Junction to Ambient (Note 7)	R <sub>0JA</sub>	625	°C/W
Operating and Storage Temperature Range	TJ, T <sub>STG</sub>	-65 to +150	°C

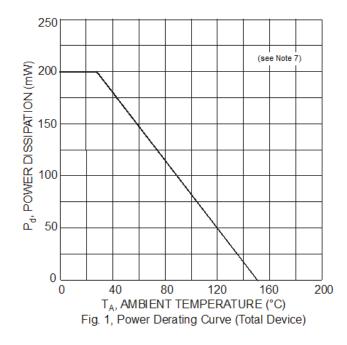
## ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 7. For a device mounted on minimum recommended pad layout with 1oz copper that is on a single-sided 1.6mm FR4 PCB; the device is measured under still air conditions whilst operating in a steady-state.

8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

#### **Thermal Characteristics – Total Device**





#### Electrical Characteristics (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS				1		
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	60			V	$I_{\rm C} = 100 \mu A, I_{\rm E} = 0$
Collector-Emitter Breakdown Voltage(Note 9)	BV <sub>CEO</sub>	40	_	_	V	$I_{\rm C} = 1.0 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	6.0			V	$I_{E} = 100 \mu A, I_{C} = 0$
Collector Cutoff Current	ICEX	_	_	50	nA	$V_{CE} = 30V, V_{EB(OFF)} = 3.0V$
Base Cutoff Current	I <sub>BL</sub>	_		50	nA	$V_{CE} = 30V, V_{EB(OFF)} = 3.0V$
ON CHARACTERISTICS (Note 9)			•		•	
DC Current Gain	hfe	40 70 100 60 30		 300 		$ \begin{array}{ll} I_{C} = & 100 \mu A, \ V_{CE} = & 1.0 V \\ I_{C} = & 1.0 m A, \ V_{CE} = & 1.0 V \\ I_{C} = & 10 m A, \ V_{CE} = & 1.0 V \\ I_{C} = & 50 m A, \ V_{CE} = & 1.0 V \\ I_{C} = & 100 m A, \ V_{CE} = & 1.0 V \\ \end{array} $
Collector-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>	—		200 300	mV	$I_{C} = 10mA, I_{B} = 1.0mA$ $I_{C} = 50mA, I_{B} = 5.0mA$
Base-Emitter Saturation Voltage	V <sub>BE(SAT)</sub>	0.65	_	850 950	mV	$I_{C} = 10$ mA, $I_{B} = 1.0$ mA $I_{C} = 50$ mA, $I_{B} = 5.0$ mA
MATCHING CHARACTERISTICS						
DC Current Gain Matching (Note 10)	h <sub>FE1</sub> / h <sub>FE2</sub>	_	1	2	%	$I_C = 2mA$ , $V_{CE} = 5V$
Base-Emitter Voltage Matching (Note 11)	V <sub>BE1</sub> - V <sub>BE2</sub>	_	1	2	mV	$I_C = 2mA$ , $V_{CE} = 5V$
Collector-Emitter Saturation Voltage (Note 10)	V <sub>CE(SAT)1</sub> / V <sub>CE(SAT)2</sub>	_	1	2	%	I <sub>C</sub> = 10mA, I <sub>B</sub> = 1.0mA
Base-Emitter Saturation Voltage (Note 10)	V <sub>BE(SAT)1</sub> / V <sub>BE(SAT)2</sub>	_	1	2	%	I <sub>C</sub> = 10mA, I <sub>B</sub> = 1.0mA
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C <sub>OBO</sub>	_	_	4.0	pF	$V_{CB} = 5.0V, f = 1.0MHz, I_E = 0$
Input Capacitance	C <sub>IBO</sub>	_	_	8.0	pF	$V_{EB} = 0.5V, f = 1.0MHz, I_{C} = 0$
Input Impedance	hıE	1.0	_	10	kΩ	
Voltage Feedback Ratio	h <sub>RE</sub>	0.5		8	x 10 <sup>-4</sup>	$V_{CE} = 10V, I_{C} = 1.0mA,$
Small Signal Current Gain	h <sub>FE</sub>	100	_	400		f = 1.0 kHz
Output Admittance	h <sub>OE</sub>	1.0		40	μS	
Current Gain-Bandwidth Product	f⊤	300	—	_	MHz	$V_{CE} = 20V$ , $I_C = 10mA$ , f = 100MHz
Noise Figure	NF	—	—	5.0	dB	$\label{eq:VCE} \begin{split} V_{CE} &= 5.0V, \ I_C = 100 \mu A, \\ R_S &= 1.0 k \Omega, \ f = 1.0 k Hz \end{split}$
SWITCHING CHARACTERISTICS						
Delay Time	t <sub>D</sub>	_	—	35	ns	$V_{CC} = 3.0V, I_{C} = 10mA,$
Rise Time	t <sub>R</sub>		—	35	ns	$V_{BE(OFF)} = -0.5V, I_{B1} = 1.0mA$
Storage Time	ts			200	ns	$V_{CC} = 3.0V, I_{C} = 10mA,$
Fall Time	t <sub>F</sub>	_	_	50	ns	$I_{B1} = I_{B2} = 1.0 \text{mA}$

Notes:

9. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%. 10. Is the ratio of one transistor compared to the other transistor.

11.  $V_{BE1}$  -  $V_{BE2}$  is the absolute difference of one transistor compared to the other transistor.



100

f = 1MHz

Cobo

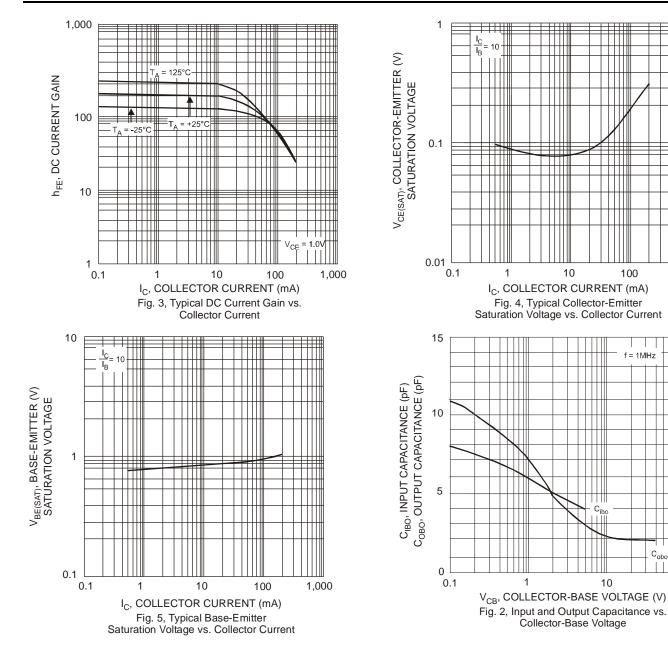
100

Cibo

10

1,000

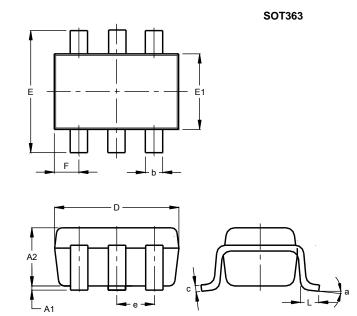
## Typical Electrical Characteristics (@T<sub>A</sub> = +25°C unless otherwise specified.)





## **Package Outline Dimensions**

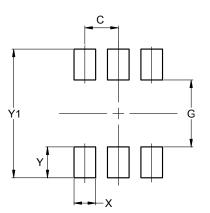
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT363							
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.90	1.00	1.00				
b	0.10	0.30	0.25				
С	0.10	0.22	0.11				
D	1.80	2.20	2.15				
Е	2.00	2.20	2.10				
E1	1.15	1.35	1.30				
е	C	).650 B	SC				
F	0.40	0.45	0.425				
L	0.25	0.40	0.30				
а	0°	8°					
All	Dimen	sions	in mm				

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Y	0.600
Y1	2.500

#### SOT363



#### IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

#### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
  - 1. are intended to implant into the body, or
  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2018, Diodes Incorporated

www.diodes.com

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Bipolar Transistors - BJT category:

Click to view products by Diodes Incorporated manufacturer:

Other Similar products are found below :

619691C MCH4017-TL-H BC546/116 BC557/116 BSW67A NTE187A NTE195A NTE2302 NTE2330 NTE63 C4460 2SA1419T-TD-H 2SA1721-O(TE85L,F) 2SA2126-E 2SB1204S-TL-E 2SC5488A-TL-H 2SD2150T100R SP000011176 FMMTA92QTA 2N2369ADCSM 2SC2412KT146S 2SC5490A-TL-H 2SD1816S-TL-E 2SD1816T-TL-E CMXT2207 TR CPH6501-TL-E MCH4021-TL-E US6T6TR 732314D CMXT3906 TR CPH3121-TL-E CPH6021-TL-H 873787E UMX21NTR EMT2T2R MCH6102-TL-E FP204-TL-E NJL0302DG 2N3583 2SA1434-TB-E 2SC3143-4-TB-E 2SD1621S-TD-E 30A02MH-TL-E NSV40301MZ4T1G NTE13 NTE15 NTE16001 NTE16006 NTE26 NTE320